MLSM MICROELECTRONICS

MQ4490A

200V/4A N-Channel MOSFET

Features

- Low $R_{DS(on)}$ & FOM
- Extremely low switching loss
- Excellent stability and uniformity
- Fast switching and soft recovery

Application

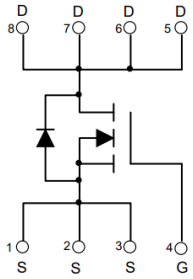
- Consumer electronic power supply
- Motor control
- Synchronous-rectification
- Isolated DC/DC convertor

Product Summary

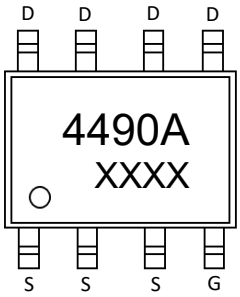
V_{DS}	$R_{DS(ON)}$ TYP	I_D
200V	65mΩ@10V	4A
	70mΩ@6V	



SOP-8 top view



Schematic diagram



4490A : Device code
XXXX : Code

Marking and pin assignment

Pb-Free RoHS Halogen-Free

Absolute Maximum Ratings (TA=25℃unless otherwise noted)

Symbol	Parameter		Rating	Unit
Common Ratings (TC=25°C Unless Otherwise Noted)				
V_{DS}	Drain-Source Breakdown Voltage		200	V
V_{GS}	Gate-Source Voltage		±20	V
T_J	Maximum Junction Temperature		150	°C
T_{STG}	Storage Temperature Range		-50 to 155	°C
I_S	Diode Continuous Forward Current	Tc=25°C	4	A
Mounted on Large Heat Sink				
I_{DM}	Pulse Drain Current Tested	Tc=25°C	40	A
I_D	Continuous Drain Current	Tc=25°C	4	A
P_D	Maximum Power Dissipation	Tc=25°C	3.1	W
$R_{\theta JA}$	Thermal Resistance Junction-Ambient		40	°C/W

Ordering Information (Example)

Type	Package	Marking	Minimum Package(pcs)	Inner Box Quantity(pcs)	Outer Carton Quantity(pcs)	Delivery Mode
MQ4490A	SOP-8	4490A	3,000	6,000	42,000	13"reel

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Electrical Characteristics (TJ=25℃ unless otherwise noted)						
Symbol	**Parameter**	**Condition**	**Min**	**Typ**	**Max**	**Unit**
Static Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
$BV_{(BR)DSS}$	Drain-Source Breakdown Voltage	V_{GS}=0V，I_D=250μA	200	--	--	V
I_{DSS}	Zero Gate Voltage Drain Current	V_{DS}=200V，V_{GS}=0V	--	--	1	μA
I_{GSS}	Gate-Body Leakage Current	V_{GS}=±20V，V_{DS}=0V	--	--	±100	nA
$V_{GS(th)}$	Gate Threshold Voltage	V_{DS}=V_{GS}，I_D=250μA	2.0	--	4.0	V
$R_{DS(on)}$	Drain-Source On-State Resistance	V_{GS}=10V， I_D=4A	--	65	80	mΩ
		V_{GS}=6V，I_D=4A	--	70	90	mΩ
Dynamic Electrical Characteristics @ TJ = 25°C (unless otherwise stated)						
C_{ISS}	Input Capacitance	V_{DS}=100V，V_{GS}=0V， f=1MHz	--	1100	--	pF
C_{OSS}	Output Capacitance		--	60	--	pF
C_{RSS}	Reverse Transfer Capacitance		--	35	--	pF
Switching Characteristics						
Q_g	Total Gate Charge	V_{DS}=100V，I_D=4A，V_{GS}=10V	--	20	--	nC
Q_{gs}	Gate Source Charge		--	7	--	nC
Q_{gd}	Gate Drain Charge		--	5.8	--	nC
$t_{d(on)}$	Turn-on Delay Time	V_{DS}=100V，I_D=4A，V_{GS}=10V，R_G=6Ω	--	8	--	nS
t_r	Turn-on Rise Time		--	2	--	nS
$t_{d(off)}$	Turn-Off Delay Time		--	16	--	nS
t_f	Turn-Off Fall Time		--	5	--	nS
Source- Drain Diode Characteristics						
V_{SD}	Forward on voltage	Tj=25℃，Is=4A	--	--	1.2	V

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Typical Operating Characteristics

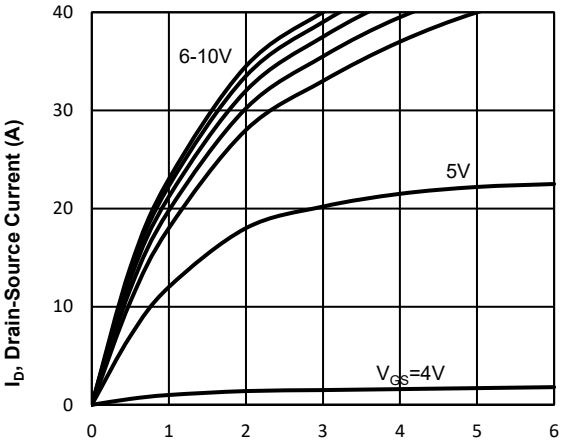


Fig1. Typical Output Characteristics

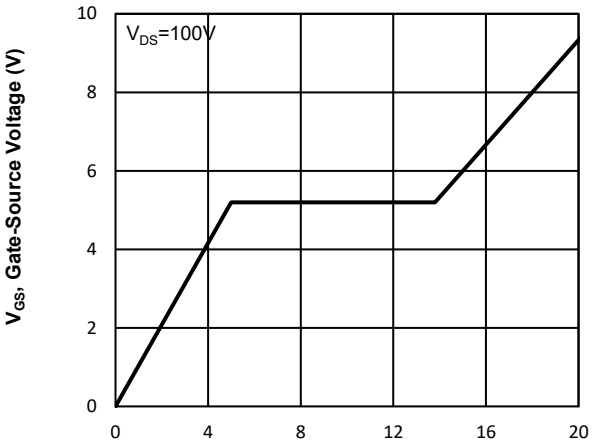


Fig2. Typical Gate Charge Vs.Gate-Source Voltage

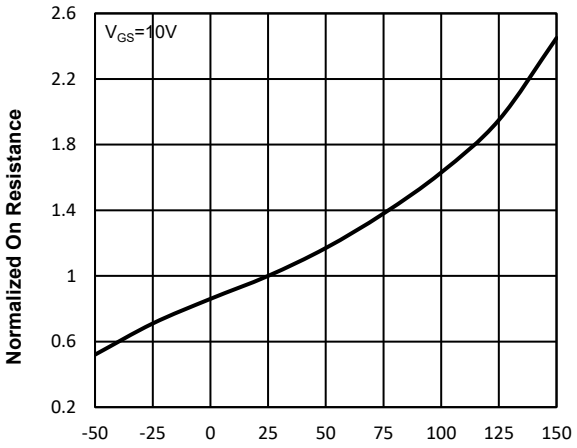


Fig3. Normalized On-Resistance Vs. Temperature

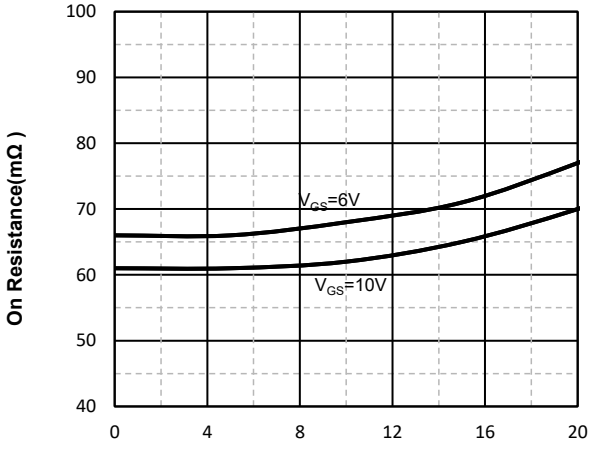


Fig4. On-Resistance Vs. Drain-Source Current

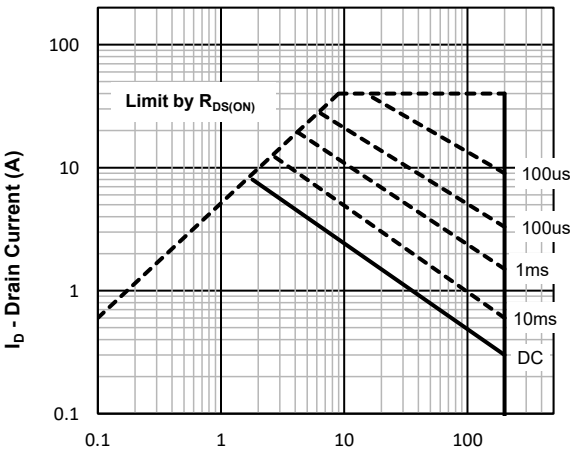


Fig5. Maximum Safe Operating Area

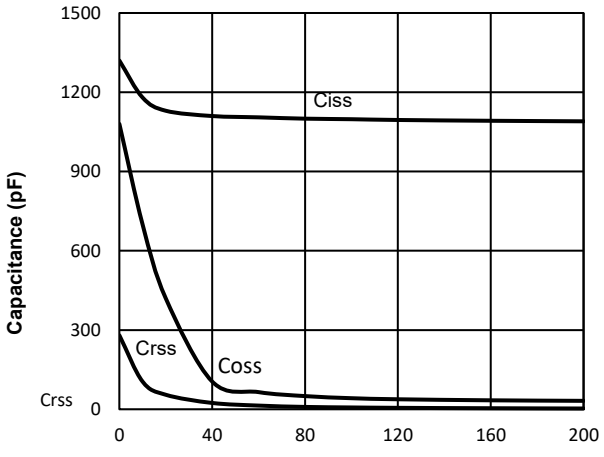
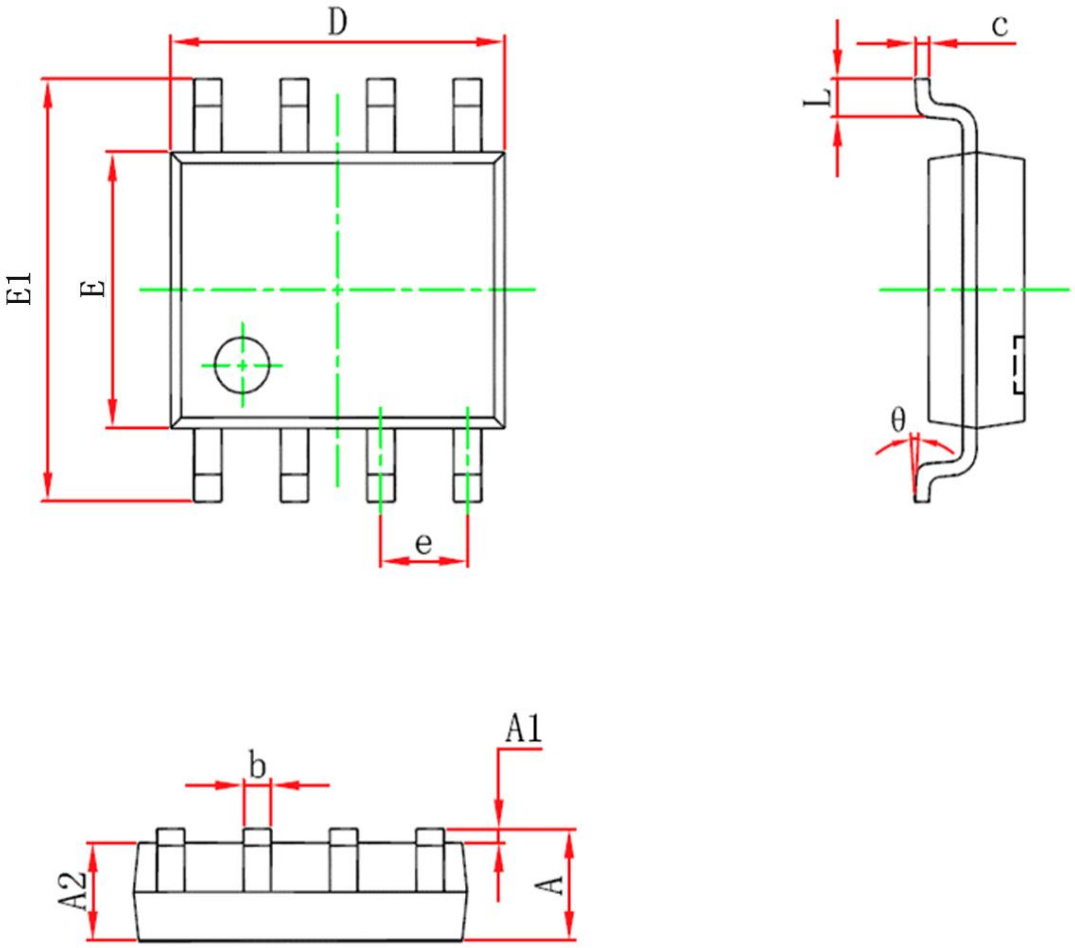


Fig6 Typical Capacitance Vs.Drain-Source Voltage

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SOP-8 Package information



Symbol	Dimensions in Millimeters(mm)		Dimensions In Inches	
	Min	Max	Min	Max
A	1.450	1.750	0.057	0.068
A1	0.100	0.250	0.003	0.009
A2	1.350	1.550	0.053	0.061
b	0.330	0.510	0.012	0.020
c	0.170	0.250	0.006	0.009
D	4.700	5.100	0.185	0.200
e	1.270(BSC)		0.050(BSC)	
E	3.800	4.000	0.149	0.157
E1	5.800	6.200	0.228	0.244
L	0.400	1.270	0.015	0.050
θ	0°	8°	0°	8°

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